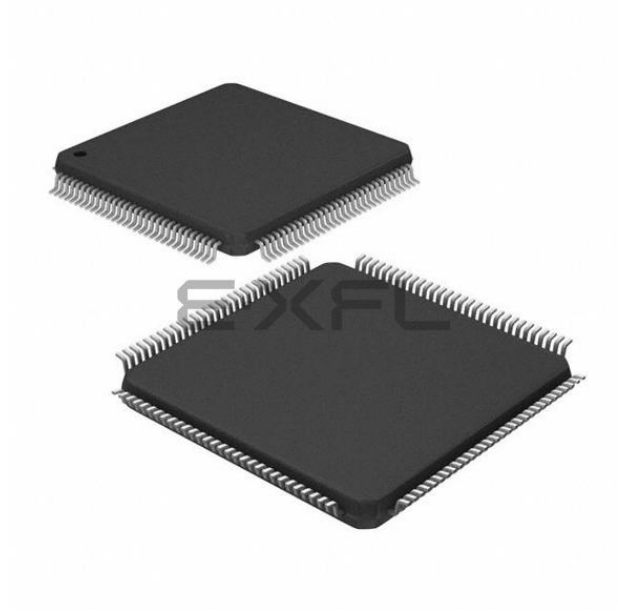

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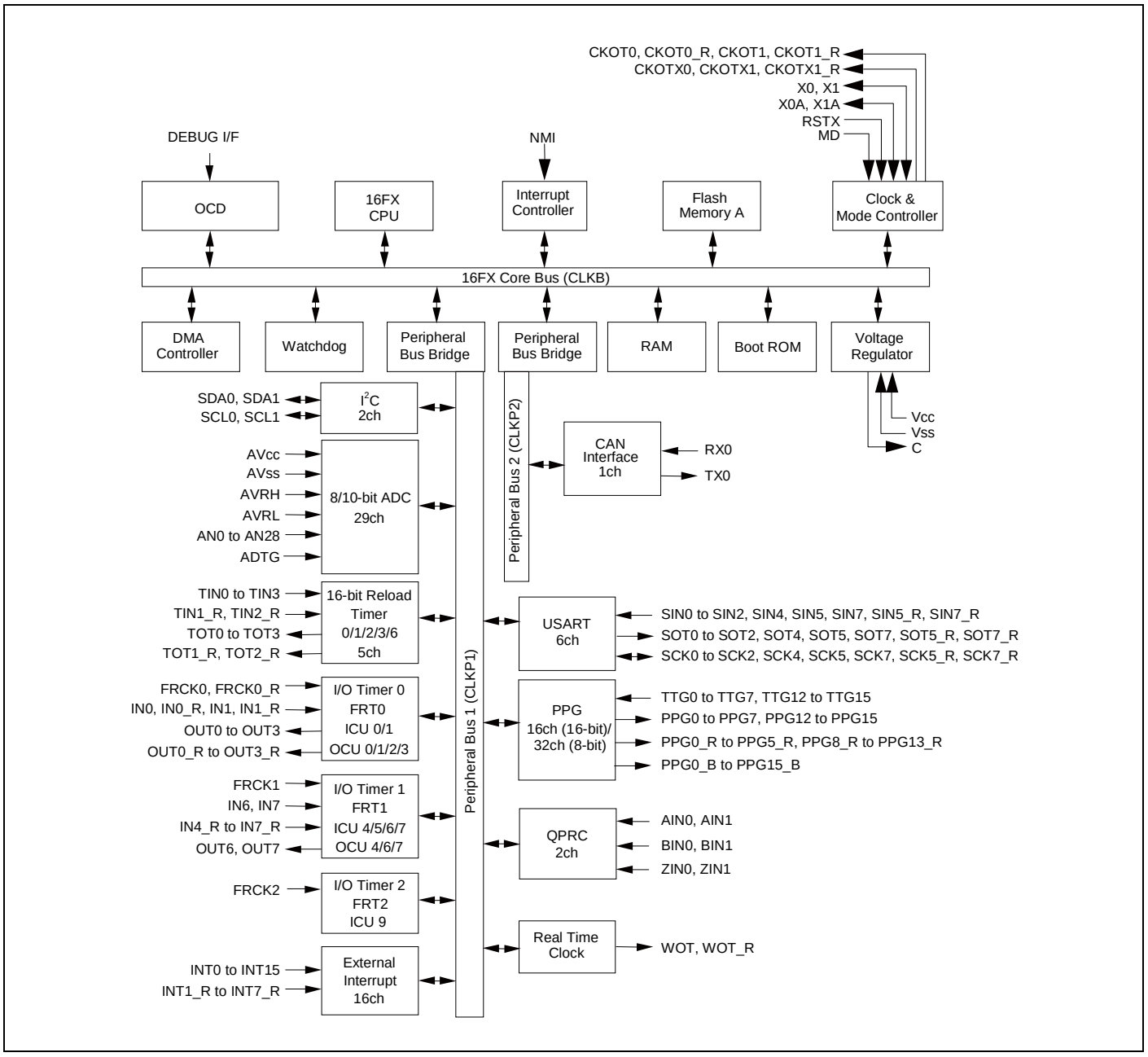
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16FX
Core Size	16-Bit
Speed	32MHz
Connectivity	CANbus, I²C, LINbus, SCI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	101
Program Memory Size	288KB (288K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 29x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb96f656rbpmc-gse2

2. Block Diagram



4. Pin Description

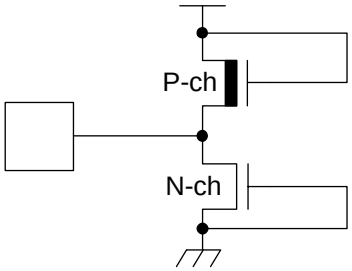
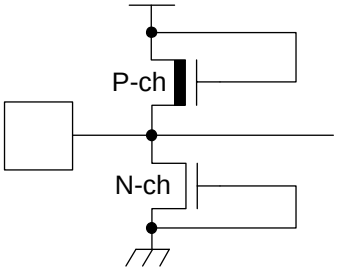
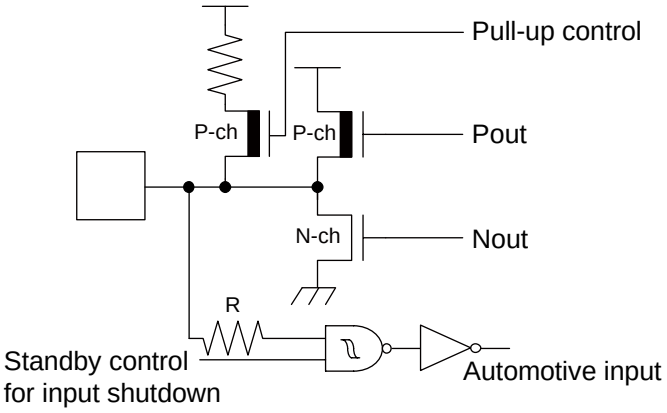
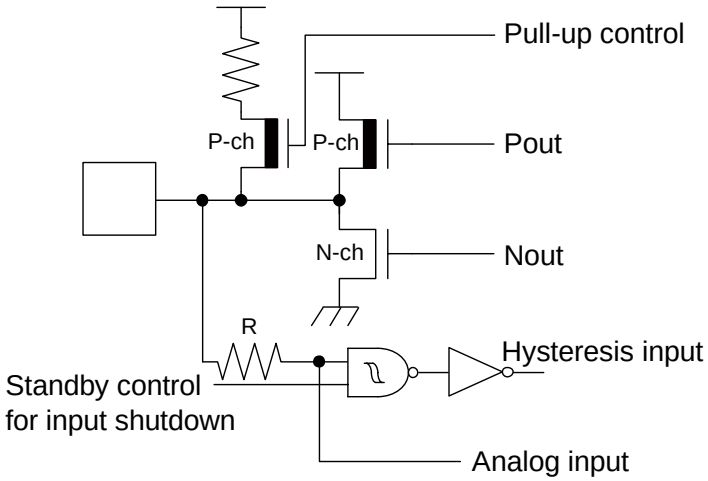
Pin name	Feature	Description
ADTG	ADC	A/D converter trigger input pin
AINn	QPRC	Quadrature Position/Revolution Counter Unit n input pin
ANn	ADC	A/D converter channel n input pin
AVcc	Supply	Analog circuits power supply pin
AVRH	ADC	A/D converter high reference voltage input pin
AVRL	ADC	A/D converter low reference voltage input pin
AVss	Supply	Analog circuits power supply pin
BINn	QPRC	Quadrature Position/Revolution Counter Unit n input pin
C	Voltage regulator	Internally regulated power supply stabilization capacitor pin
CKOTn	Clock Output function	Clock Output function n output pin
CKOTn_R	Clock Output function	Relocated Clock Output function n output pin
CKOTXn	Clock Output function	Clock Output function n inverted output pin
CKOTXn_R	Clock Output function	Relocated Clock Output function n inverted output pin
DEBUG I/F	OCD	On Chip Debugger input/output pin
FRCKn	Free-Running Timer	Free-Running Timer n input pin
FRCKn_R	Free-Running Timer	Relocated Free-Running Timer n input pin
INn	ICU	Input Capture Unit n input pin
INn_R	ICU	Relocated Input Capture Unit n input pin
INTn	External Interrupt	External Interrupt n input pin
INTn_R	External Interrupt	Relocated External Interrupt n input pin
MD	Core	Input pin for specifying the operating mode
NMI	External Interrupt	Non-Maskable Interrupt input pin
OUTn	OCU	Output Compare Unit n waveform output pin
OUTn_R	OCU	Relocated Output Compare Unit n waveform output pin
Pnn_m	GPIO	General purpose I/O pin
PPGn	PPG	Programmable Pulse Generator n output pin (16bit/8bit)
PPGn_R	PPG	Relocated Programmable Pulse Generator n output pin (16bit/8bit)
PPGn_B	PPG	Programmable Pulse Generator n output pin (16bit/8bit)
RSTX	Core	Reset input pin
RXn	CAN	CAN interface n RX input pin
SCKn	USART	USART n serial clock input/output pin
SCKn_R	USART	Relocated USART n serial clock input/output pin
SCLn	I^2C	I^2C interface n clock I/O input/output pin
SDAn	I^2C	I^2C interface n serial data I/O input/output pin
SINn	USART	USART n serial data input pin
SINn_R	USART	Relocated USART n serial data input pin
SOTn	USART	USART n serial data output pin
SOTn_R	USART	Relocated USART n serial data output pin
TINn	Reload Timer	Reload Timer n event input pin
TINn_R	Reload Timer	Relocated Reload Timer n event input pin

Pin name	Feature	Description
TOTn	Reload Timer	Reload Timer n output pin
TOTn_R	Reload Timer	Relocated Reload Timer n output pin
TTGn	PPG	Programmable Pulse Generator n trigger input pin
TXn	CAN	CAN interface n TX output pin
Vcc	Supply	Power supply pin
Vss	Supply	Power supply pin
WOT	RTC	Real Time clock output pin
WOT_R	RTC	Relocated Real Time clock output pin
X0	Clock	Oscillator input pin
X0A	Clock	Subclock Oscillator input pin
X1	Clock	Oscillator output pin
X1A	Clock	Subclock Oscillator output pin
ZINn	QPRC	Quadrature Position/Revolution Counter Unit n input pin

5. Pin Circuit Type

Pin no.	I/O circuit type*	Pin name
1	Supply	Vss
2	F	C
3	M	P03_7 / INT1 / SIN1
4	H	P13_0 / INT2 / SOT1
5	M	P13_1 / INT3 / SCK1
6	H	P13_2 / PPG0 / TIN0 / FRCK1
7	H	P13_3 / PPG1 / TOT0 / WOT
8	M	P13_4 / SIN0 / INT6
9	H	P13_5 / SOT0 / ADTG / INT7
10	M	P13_6 / SCK0 / CKOTX0
11	H	P13_7 / PPG2 / CKOT0
12	N	P04_4 / PPG3 / SDA0
13	N	P04_5 / PPG4 / SCL0
14	I	P06_0 / AN0 / SCK5
15	K	P06_1 / AN1 / SOT5
16	I	P06_2 / AN2 / INT5 / SIN5
17	K	P06_3 / AN3 / FRCK0
18	K	P06_4 / AN4 / IN0 / TTG0 / TTG4
19	K	P06_5 / AN5 / IN1 / TTG1 / TTG5
20	K	P06_6 / AN6 / TIN1 / IN4_R
21	K	P06_7 / AN7 / TOT1 / IN5_R
22	Supply	AVcc
23	G	AVRH
24	G	AVRL
25	Supply	AVss
26	K	P05_0 / AN8
27	K	P05_1 / AN9
28	K	P05_2 / AN10 / OUT2
29	K	P05_3 / AN11 / OUT3
30	Supply	Vcc
31	Supply	Vss
32	K	P05_4 / AN12 / INT2_R / WOT_R
33	K	P05_5 / AN13
34	K	P05_6 / AN14 / TIN2
35	K	P05_7 / AN15 / TOT2
36	K	P08_0 / AN16

Pin no.	I/O circuit type*	Pin name
76	H	P11_5 / PPG4_R
77	H	P11_6 / FRCK0_R / ZIN1
78	H	P11_7 / IN0_R / AIN1
79	H	P12_0 / IN1_R / BIN1
80	H	P12_1 / TIN1_R / PPG0_B
81	H	P12_2 / TOT1_R / PPG1_B
82	H	P12_3 / OUT2_R
83	H	P12_4 / OUT3_R
84	H	P12_5 / TIN2_R / PPG2_B
85	H	P12_6 / TOT2_R / PPG3_B
86	H	P12_7 / INT1_R
87	H	P00_0 / INT3_R / FRCK2
88	H	P00_1 / INT4_R
89	H	P00_2 / INT5_R
90	Supply	Vcc
91	Supply	Vss
92	H	P00_3 / INT6_R / PPG8_B
93	H	P00_4 / INT7_R / PPG9_B
94	H	P00_5 / IN6 / TTG2 / TTG6 / PPG10_B
95	H	P00_6 / IN7 / TTG3 / TTG7 / PPG11_B
96	H	P00_7 / INT14
97	M	P01_0 / SCK7
98	H	P01_1 / CKOT1 / OUT0 / SOT7
99	M	P01_2 / CKOTX1 / OUT1 / INT15 / SIN7
100	H	P01_3 / PPG5
101	M	P01_4 / SIN4 / INT8
102	H	P01_5 / SOT4
103	M	P01_6 / SCK4 / TTG12
104	M	P01_7 / CKOTX1_R / INT9 / TTG13 / ZIN0 / SCK7_R
105	H	P02_0 / CKOT1_R / INT10 / TTG14 / AIN0 / SOT7_R
106	H	P02_1 / IN6_R / TTG15
107	M	P02_2 / IN7_R / CKOT0_R / INT12 / BIN0 / SIN7_R
108	H	P02_3 / PPG12_B
109	H	P02_4 / PPG13_B
110	M	P02_5 / OUT0_R / INT13 / SIN5_R
111	H	P02_6 / OUT1_R
112	H	P02_7 / PPG5_R
113	H	P03_0 / PPG4_B
114	H	P03_1 / PPG5_B

Type	Circuit	Remarks
F		Power supply input protection circuit
G		■A/D converter ref+ (AVRH)/ ref- (AVRL) power supply input pin with protection circuit ■Without protection circuit against V_{CC} for pins AVRH/AVRL
H		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■Automotive input with input shutdown function ■Programmable pull-up resistor
I		■CMOS level output (I_{OL} = 4mA, I_{OH} = -4mA) ■CMOS hysteresis input with input shutdown function ■Programmable pull-up resistor ■Analog input

Vector number	Offset in vector table	Vector name	Cleared by DMA	Index in ICR to program	Description
40	$35C_H$	PPG2	Yes	40	Programmable Pulse Generator 2
41	358_H	PPG3	Yes	41	Programmable Pulse Generator 3
42	354_H	PPG4	Yes	42	Programmable Pulse Generator 4
43	350_H	PPG5	Yes	43	Programmable Pulse Generator 5
44	$34C_H$	PPG6	Yes	44	Programmable Pulse Generator 6
45	348_H	PPG7	Yes	45	Programmable Pulse Generator 7
46	344_H	PPG8	Yes	46	Programmable Pulse Generator 8
47	340_H	PPG9	Yes	47	Programmable Pulse Generator 9
48	$33C_H$	PPG10	Yes	48	Programmable Pulse Generator 10
49	338_H	PPG11	Yes	49	Programmable Pulse Generator 11
50	334_H	PPG12	Yes	50	Programmable Pulse Generator 12
51	330_H	PPG13	Yes	51	Programmable Pulse Generator 13
52	$32C_H$	PPG14	Yes	52	Programmable Pulse Generator 14
53	328_H	PPG15	Yes	53	Programmable Pulse Generator 15
54	324_H	-	-	54	Reserved
55	320_H	-	-	55	Reserved
56	$31C_H$	-	-	56	Reserved
57	318_H	-	-	57	Reserved
58	314_H	RLT0	Yes	58	Reload Timer 0
59	310_H	RLT1	Yes	59	Reload Timer 1
60	$30C_H$	RLT2	Yes	60	Reload Timer 2
61	308_H	RLT3	Yes	61	Reload Timer 3
62	304_H	-	-	62	Reserved
63	300_H	-	-	63	Reserved
64	$2FC_H$	RLT6	Yes	64	Reload Timer 6
65	$2F8_H$	ICU0	Yes	65	Input Capture Unit 0
66	$2F4_H$	ICU1	Yes	66	Input Capture Unit 1
67	$2F0_H$	-	-	67	Reserved
68	$2EC_H$	-	-	68	Reserved
69	$2E8_H$	ICU4	Yes	69	Input Capture Unit 4
70	$2E4_H$	ICU5	Yes	70	Input Capture Unit 5
71	$2E0_H$	ICU6	Yes	71	Input Capture Unit 6
72	$2DC_H$	ICU7	Yes	72	Input Capture Unit 7
73	$2D8_H$	-	-	73	Reserved
74	$2D4_H$	ICU9	Yes	74	Input Capture Unit 9
75	$2D0_H$	-	-	75	Reserved
76	$2CC_H$	-	-	76	Reserved
77	$2C8_H$	OCU0	Yes	77	Output Compare Unit 0
78	$2C4_H$	OCU1	Yes	78	Output Compare Unit 1
79	$2C0_H$	OCU2	Yes	79	Output Compare Unit 2
80	$2BC_H$	OCU3	Yes	80	Output Compare Unit 3

Vector number	Offset in vector table	Vector name	Cleared by DMA	Index in ICR to program	Description
121	218_H	-	-	121	Reserved
122	214_H	-	-	122	Reserved
123	210_H	-	-	123	Reserved
124	$20C_H$	-	-	124	Reserved
125	208_H	-	-	125	Reserved
126	204_H	-	-	126	Reserved
127	200_H	-	-	127	Reserved
128	$1FC_H$	-	-	128	Reserved
129	$1F8_H$	-	-	129	Reserved
130	$1F4_H$	-	-	130	Reserved
131	$1F0_H$	-	-	131	Reserved
132	$1EC_H$	-	-	132	Reserved
133	$1E8_H$	FLASHA	Yes	133	Flash memory A interrupt
134	$1E4_H$	-	-	134	Reserved
135	$1E0_H$	-	-	135	Reserved
136	$1DC_H$	-	-	136	Reserved
137	$1D8_H$	QPRC0	Yes	137	Quad Position/Revolution counter 0
138	$1D4_H$	QPRC1	Yes	138	Quad Position/Revolution counter 1
139	$1D0_H$	ADCRC0	No	139	A/D Converter 0 - Range Comparator
140	$1CC_H$	-	-	140	Reserved
141	$1C8_H$	-	-	141	Reserved
142	$1C4_H$	-	-	142	Reserved
143	$1C0_H$	-	-	143	Reserved

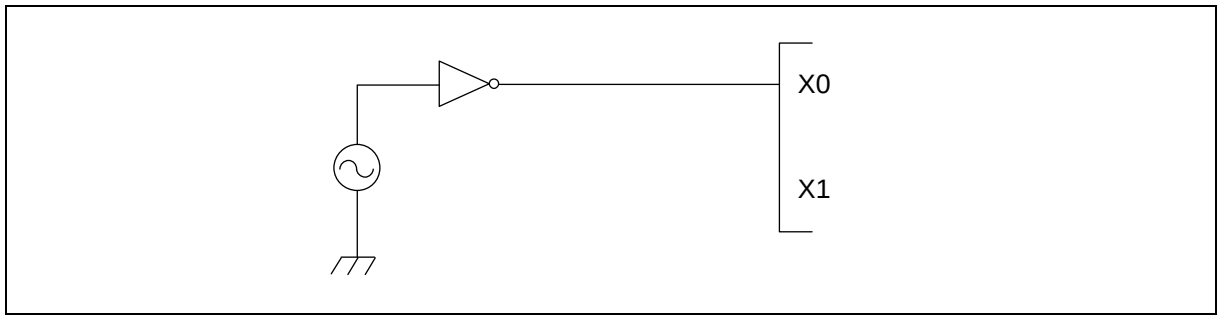
3. External clock usage

The permitted frequency range of an external clock depends on the oscillator type and configuration.

See AC Characteristics for detailed modes and frequency limits. Single and opposite phase external clocks must be connected as follows:

(1) Single phase external clock for Main oscillator

When using a single phase external clock for the Main oscillator, X0 pin must be driven and X1 pin left open. And supply 1.8V power to the external clock.

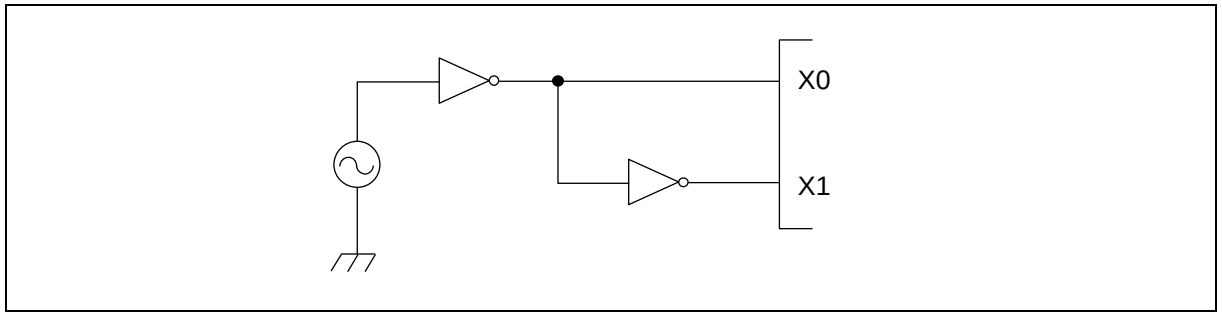


(2) Single phase external clock for Sub oscillator

When using a single phase external clock for the Sub oscillator, “External clock mode” must be selected and X0A/P04_0 pin must be driven. X1A/P04_1 pin can be configured as GPIO.

(3) Opposite phase external clock

When using an opposite phase external clock, X1 (X1A) pins must be supplied with a clock signal which has the opposite phase to the X0 (X0A) pins. Supply level on X0 and X1 pins must be 1.8V.



4. Notes on PLL clock mode operation

If the microcontroller is operated with PLL clock mode and no external oscillator is operating or no external clock is supplied, the microcontroller attempts to work with the free oscillating PLL. Performance of this operation, however, cannot be guaranteed.

5. Power supply pins (Vcc/Vss)

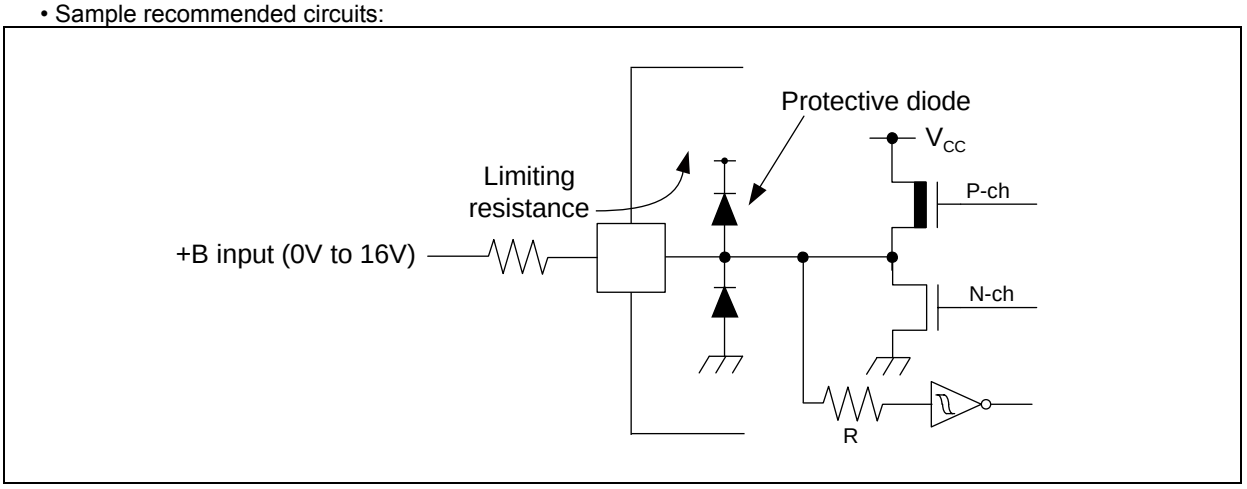
It is required that all V_{CC}-level as well as all V_{SS}-level power supply pins are at the same potential. If there is more than one V_{CC} or V_{SS} level, the device may operate incorrectly or be damaged even within the guaranteed operating range.

Vcc and Vss pins must be connected to the device from the power supply with lowest possible impedance.

The smoothing capacitor at Vcc pin must use the one of a capacity value that is larger than Cs.

Besides this, as a measure against power supply noise, it is required to connect a bypass capacitor of about 0.1μF between Vcc and Vss pins as close as possible to Vcc and Vss pins.

• Sample recommended circuits:



*5: The maximum permitted power dissipation depends on the ambient temperature, the air flow velocity and the thermal conductance of the package on the PCB.
The actual power dissipation depends on the customer application and can be calculated as follows:
$P_D = P_{IO} + P_{INT}$

$P_{IO} = \Sigma (V_{OL} \times I_{OL} + V_{OH} \times I_{OH})$ (I/O load power dissipation, sum is performed on all I/O ports)

$P_{INT} = V_{CC} \times (I_{CC} + I_A)$ (internal power dissipation)

I_{CC} is the total core current consumption into V_{CC} as described in the “DC characteristics” and depends on the selected operation mode and clock frequency and the usage of functions like Flash programming.
I_A is the analog current consumption into AV_{CC}.
*6: Worst case value for a package mounted on single layer PCB at specified T_A without air flow.
*7: Write/erase to a large sector in flash memory is warranted with $T_A \leq +105°C$.

WARNING

Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

14.3 DC Characteristics

14.3.1 Current Rating

(V_{CC} = AV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current in Run modes[*1]	I_{CCPLL}	Vcc	PLL Run mode with CLKS1/2 = CLKB = CLKP1/2 = 32MHz Flash 0 wait (CLKRC and CLKSC stopped)	-	27	-	mA	T_A = +25°C
				-	-	37	mA	T_A = +105°C
				-	-	38.5	mA	T_A = +125°C
	I_{CCMAIN}		Main Run mode with CLKS1/2 = CLKB = CLKP1/2 = 4MHz Flash 0 wait (CLKPLL, CLKSC and CLKRC stopped)	-	3.5	-	mA	T_A = +25°C
				-	-	8	mA	T_A = +105°C
				-	-	9.5	mA	T_A = +125°C
	I_{CCRCH}		RC Run mode with CLKS1/2 = CLKB = CLKP1/2 = CLKRC = 2MHz Flash 0 wait (CLKMC, CLKPLL and CLKSC stopped)	-	1.8	-	mA	T_A = +25°C
				-	-	6	mA	T_A = +105°C
				-	-	7.5	mA	T_A = +125°C
	I_{CCRCL}		RC Run mode with CLKS1/2 = CLKB = CLKP1/2 = CLKRC = 100kHz Flash 0 wait (CLKMC, CLKPLL and CLKSC stopped)	-	0.16	-	mA	T_A = +25°C
				-	-	3.5	mA	T_A = +105°C
				-	-	5	mA	T_A = +125°C
	I_{CCSUB}		Sub Run mode with CLKS1/2 = CLKB = CLKP1/2 = 32kHz Flash 0 wait (CLKMC, CLKPLL and CLKRC stopped)	-	0.1	-	mA	T_A = +25°C
				-	-	3.3	mA	T_A = +105°C
				-	-	4.8	mA	T_A = +125°C

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current in Sleep modes[*1]	I_{CCSPLL}	Vcc	PLL Sleep mode with CLKS1/2 = CLKP1/2 = 32MHz (CLKRC and CLKSC stopped)	-	8.5	-	mA	T_A = +25°C
				-	-	14	mA	T_A = +105°C
				-	-	15.5	mA	T_A = +125°C
	$I_{CCSMAIN}$		Main Sleep mode with CLKS1/2 = CLKP1/2 = 4MHz, SMCR:LPMSS = 0 (CLKPLL, CLKRC and CLKSC stopped)	-	1	-	mA	T_A = +25°C
				-	-	4.5	mA	T_A = +105°C
				-	-	6	mA	T_A = +125°C
	I_{CCSRCH}		RC Sleep mode with CLKS1/2 = CLKP1/2 = CLKRC = 2MHz, SMCR:LPMSS = 0 (CLKMC, CLKPLL and CLKSC stopped)	-	0.6	-	mA	T_A = +25°C
				-	-	3.8	mA	T_A = +105°C
				-	-	5.3	mA	T_A = +125°C
	I_{CCSRCL}		RC Sleep mode with CLKS1/2 = CLKP1/2 = CLKRC = 100kHz (CLKMC, CLKPLL and CLKSC stopped)	-	0.07	-	mA	T_A = +25°C
				-	-	2.8	mA	T_A = +105°C
				-	-	4.3	mA	T_A = +125°C
	I_{CCSUB}		Sub Sleep mode with CLKS1/2 = CLKP1/2 = 32kHz, (CLKMC, CLKPLL and CLKRC stopped)	-	0.04	-	mA	T_A = +25°C
				-	-	2.5	mA	T_A = +105°C
				-	-	4	mA	T_A = +125°C

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current in Timer modes*2	I_{CCTPLL}	Vcc	PLL Timer mode with CLKPLL = 32MHz (CLKRC and CLKSC stopped)	-	1800	2250	µA	T_A = +25°C
				-	-	3220	µA	T_A = +105°C
				-	-	4205	µA	T_A = +125°C
	$I_{CCTMAIN}$		Main Timer mode with CLKMC = 4MHz, SMCR:LPMSS = 0 (CLKPLL, CLKRC and CLKSC stopped)	-	285	330	µA	T_A = +25°C
				-	-	1195	µA	T_A = +105°C
				-	-	2165	µA	T_A = +125°C
	I_{CCTRCH}		RC Timer mode with CLKRC = 2MHz, SMCR:LPMSS = 0 (CLKPLL, CLKMC and CLKSC stopped)	-	160	215	µA	T_A = +25°C
				-	-	1095	µA	T_A = +105°C
				-	-	2075	µA	T_A = +125°C
	I_{CCTRCL}		RC Timer mode with CLKRC = 100kHz (CLKPLL, CLKMC and CLKSC stopped)	-	35	75	µA	T_A = +25°C
				-	-	905	µA	T_A = +105°C
				-	-	1880	µA	T_A = +125°C
	I_{CCTSUB}		Sub Timer mode with CLKSC = 32kHz (CLKMC, CLKPLL and CLKRC stopped)	-	25	65	µA	T_A = +25°C
				-	-	885	µA	T_A = +105°C
				-	-	1850	µA	T_A = +125°C

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current in Stop mode*3	I_{CCH}	Vcc	-	-	20	60	µA	T_A = +25°C
				-	-	880	µA	T_A = +105°C
				-	-	1845	µA	T_A = +125°C
Flash Power Down current	$I_{CCFLASHPD}$		-	-	36	70	µA	
Power supply current for active Low Voltage detector*4	I_{CCLVD}		Low voltage detector enabled	-	5	-	µA	T_A = +25°C
				-	-	12.5	µA	T_A = +125°C
Flash Write/ Erase current*5	$I_{CCFLASH}$		-	-	12.5	-	mA	T_A = +25°C
				-	-	20	mA	T_A = +125°C

*1: The power supply current is measured with a 4MHz external clock connected to the Main oscillator and a 32kHz external clock connected to the Sub oscillator. See chapter “Standby mode and voltage regulator control circuit” of the Hardware Manual for further details about voltage regulator control. Current for "On Chip Debugger" part is not included. Power supply current in Run mode does not include Flash Write / Erase current.

*2: The power supply current in Timer mode is the value when Flash is in Power-down / reset mode.

When Flash is not in Power-down / reset mode, $I_{CCFLASHPD}$ must be added to the Power supply current.

The power supply current is measured with a 4MHz external clock connected to the Main oscillator and a 32kHz external clock connected to the Sub oscillator. The current for "On Chip Debugger" part is not included.

*3: The power supply current in Stop mode is the value when Flash is in Power-down / reset mode.

When Flash is not in Power-down / reset mode, $I_{CCFLASHPD}$ must be added to the Power supply current.

*4: When low voltage detector is enabled, I_{CCLVD} must be added to Power supply current.

*5: When Flash Write / Erase program is executed, $I_{CCFLASH}$ must be added to Power supply current.

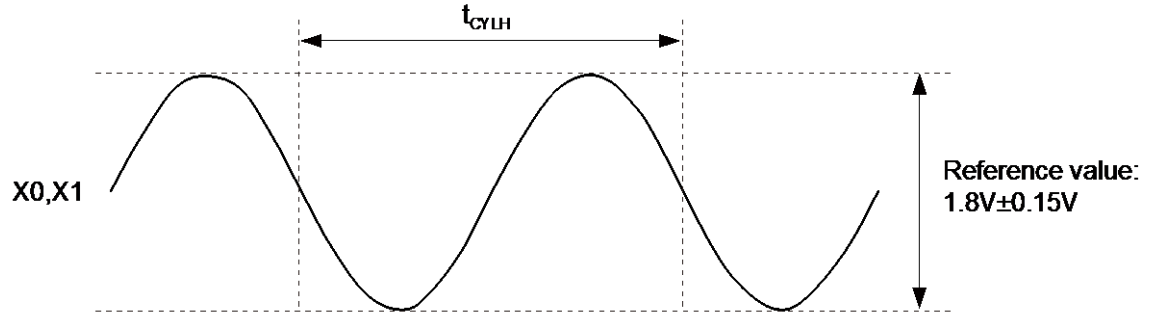
14.4 AC Characteristics

14.4.1 Main Clock Input Characteristics

(V_{CC} = AV_{CC} = 2.7V to 5.5V, VD=1.8V±0.15V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C)

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Input frequency	f_C	X0, X1	4	-	8	MHz	When using a crystal oscillator, PLL off
			-	-	8	MHz	When using an opposite phase external clock, PLL off
			4	-	8	MHz	When using a crystal oscillator or opposite phase external clock, PLL on
Input frequency	f_{FCI}	X0	-	-	8	MHz	When using a single phase external clock in “Fast Clock Input mode”, PLL off
			4	-	8	MHz	When using a single phase external clock in “Fast Clock Input mode”, PLL on
Input clock cycle	t_{CYLH}	-	125	-	-	ns	
Input clock pulse width	P_{WH}, P_{WL}	-	55	-	-	ns	

When using the crystal oscillator



The amplitude changes by resistance, capacity which added outside or the difference of the device.

14.4.8 USART Timing

(V_{CC} = AV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C, C_L=50pF)

Parameter	Symbol	Pin name	Conditions	4.5V ≤ V_{CC} < 5.5V		2.7V ≤ V_{CC} < 4.5V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t_{SCYC}	SCKn	Internal shift clock mode	$4t_{CLKP1}$	-	$4t_{CLKP1}$	-	ns
SCK ↓ → SOT delay time	t_{SLOVI}	SCKn, SOTn		- 20	+ 20	- 30	+ 30	ns
SOT → SCK ↑ delay time	t_{OVSHI}	SCKn, SOTn		$N \times t_{CLKP1}$ – 20*	-	$N \times t_{CLKP1}$ – 30*	-	ns
SIN → SCK ↑ setup time	t_{IVSHI}	SCKn, SINn		t_{CLKP1} + 45	-	t_{CLKP1} + 55	-	ns
SCK ↑ → SIN hold time	t_{SHIXI}	SCKn, SINn		0	-	0	-	ns
Serial clock "L" pulse width	t_{SLSH}	SCKn	External shift clock mode	t_{CLKP1} + 10	-	t_{CLKP1} + 10	-	ns
Serial clock "H" pulse width	t_{SHSL}	SCKn		t_{CLKP1} + 10	-	t_{CLKP1} + 10	-	ns
SCK ↓ → SOT delay time	t_{SLOVE}	SCKn, SOTn		-	$2t_{CLKP1}$ + 45	-	$2t_{CLKP1}$ + 55	ns
SIN → SCK ↑ setup time	t_{IVSHE}	SCKn, SINn		$t_{CLKP1}/2$ + 10	-	$t_{CLKP1}/2$ + 10	-	ns
SCK ↑ → SIN hold time	t_{SHIXE}	SCKn, SINn		t_{CLKP1} + 10	-	t_{CLKP1} + 10	-	ns
SCK fall time	t_F	SCKn		-	20	-	20	ns
SCK rise time	t_R	SCKn		-	20	-	20	ns

Notes:
- AC characteristic in CLK synchronized mode.
- C_L is the load capacity value of pins when testing.
- Depending on the used machine clock frequency, the maximum possible baud rate can be limited by some parameters. These parameters are shown in “MB96600 series HARDWARE MANUAL”.
- t_{CLKP1} indicates the peripheral clock 1 (CLKP1), Unit: ns
- These characteristics only guarantee the same relocate port number.
  For example, the combination of SCKn and SOTn_R is not guaranteed.

*: Parameter N depends on t_{SCYC} and can be calculated as follows:

- If $t_{SCYC} = 2 \times k \times t_{CLKP1}$, then N = k, where k is an integer > 2
- If $t_{SCYC} = (2 \times k + 1) \times t_{CLKP1}$, then N = k + 1, where k is an integer > 1

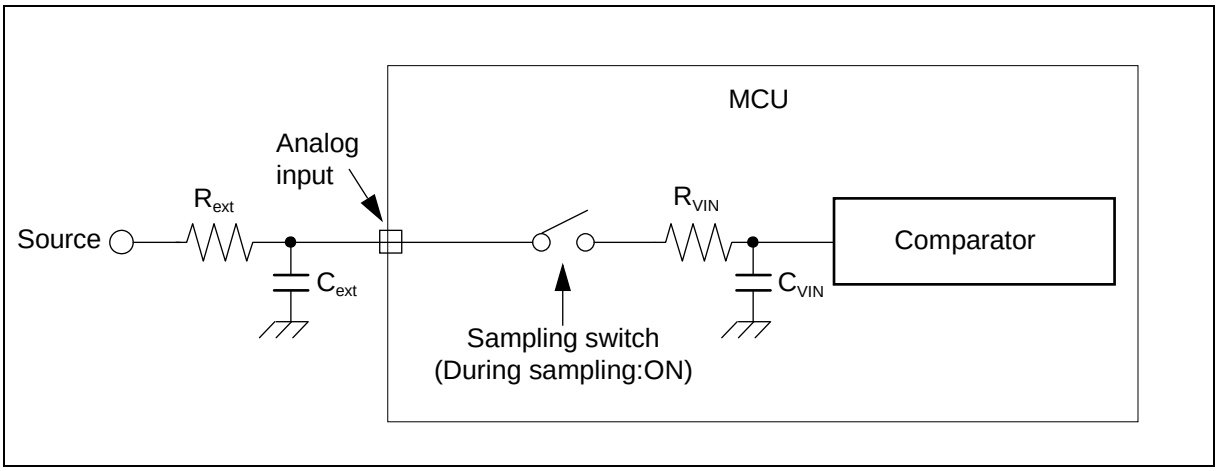
Examples:

t_{SCYC}	N
$4 \times t_{CLKP1}$	2
$5 \times t_{CLKP1}$, $6 \times t_{CLKP1}$	3
$7 \times t_{CLKP1}$, $8 \times t_{CLKP1}$	4
...	...

14.5.2 Accuracy and Setting of the A/D Converter Sampling Time

If the external impedance is too high or the sampling time too short, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting the A/D conversion precision.

To satisfy the A/D conversion precision, a sufficient sampling time must be selected. The required sampling time (Tsamp) depends on the external driving impedance R_{ext}, the board capacitance of the A/D converter input pin C_{ext} and the AV_{CC} voltage level. The following replacement model can be used for the calculation:



R_{ext}: External driving impedance

C_{ext}: Capacitance of PCB at A/D converter input

C_{VIN}: Analog input capacity (I/O, analog switch and ADC are contained)

R_{VIN}: Analog input impedance (I/O, analog switch and ADC are contained)

The following approximation formula for the replacement model above can be used:

$$Tsamp = 7.62 \times (Rext \times Cext + (Rext + R_{VIN}) \times C_{VIN})$$

- Do not select a sampling time below the absolute minimum permitted value. (0.5µs for $4.5V \le AV_{CC} \le 5.5V$, 1.2µs for $2.7V \le AV_{CC} < 4.5V$)
- If the sampling time cannot be sufficient, connect a capacitor of about 0.1µF to the analog input pin.
- A big external driving impedance also adversely affects the A/D conversion precision due to the pin input leakage current IIL (static current before the sampling switch) or the analog input leakage current IAIN (total leakage current of pin input and comparator during sampling). The effect of the pin input leakage current IIL cannot be compensated by an external capacitor.
- The accuracy gets worse as |AVRH - AVRL| becomes smaller.

14.5.3 Definition of A/D Converter Terms

Resolution : Analog variation that is recognized by an A/D converter.

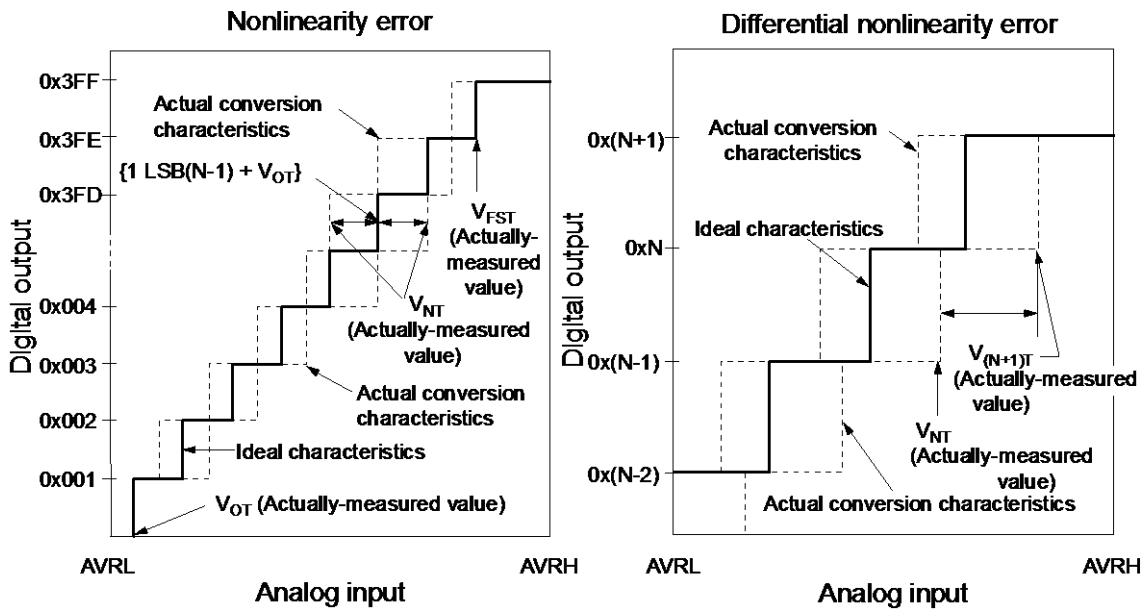
Nonlinearity error : Deviation of the actual conversion characteristics from a straight line that connects the zero transition point (0b0000000000 ⟷ 0b0000000001) to the full-scale transition point (0b1111111110 ⟷ 0b1111111111).

Differential nonlinearity error : Deviation from the ideal value of the input voltage that is required to change the output code by 1LSB.

Total error : Difference between the actual value and the theoretical value. The total error includes zero transition error, full-scale transition error and nonlinearity error.

Zero transition voltage: Input voltage which results in the minimum conversion value.

Full scale transition voltage: Input voltage which results in the maximum conversion value.



$$\text{Nonlinearity error of digital output N} = \frac{V_{NT} - \{1LSB \times (N - 1) + V_{OT}\}}{1LSB} \text{ [LSB]}$$

$$\text{Differential nonlinearity error of digital output N} = \frac{V_{(N+1)T} - V_{NT}}{1LSB} - 1 \text{ [LSB]}$$

$$1LSB = \frac{V_{FST} - V_{OT}}{1022}$$

N : A/D converter digital output value.

V_{OT} : Voltage at which the digital output changes from 0x000 to 0x001.

V_{FST} : Voltage at which the digital output changes from 0x3FE to 0x3FF.

V_{NT} : Voltage at which the digital output changes from 0x(N − 1) to 0xN.

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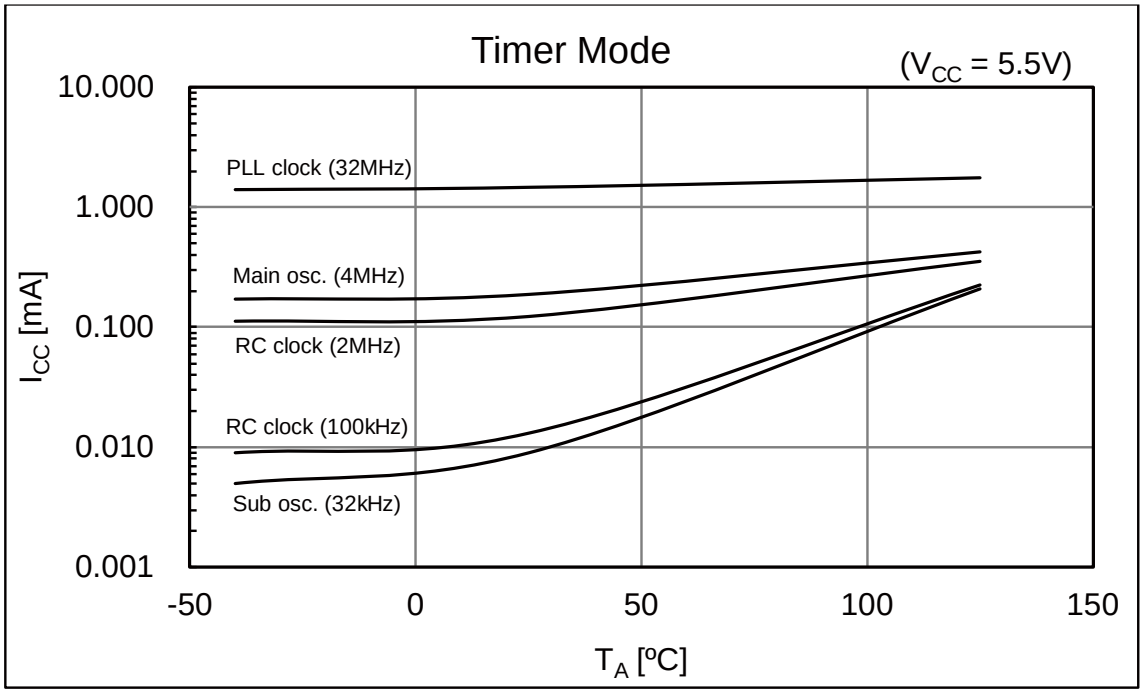
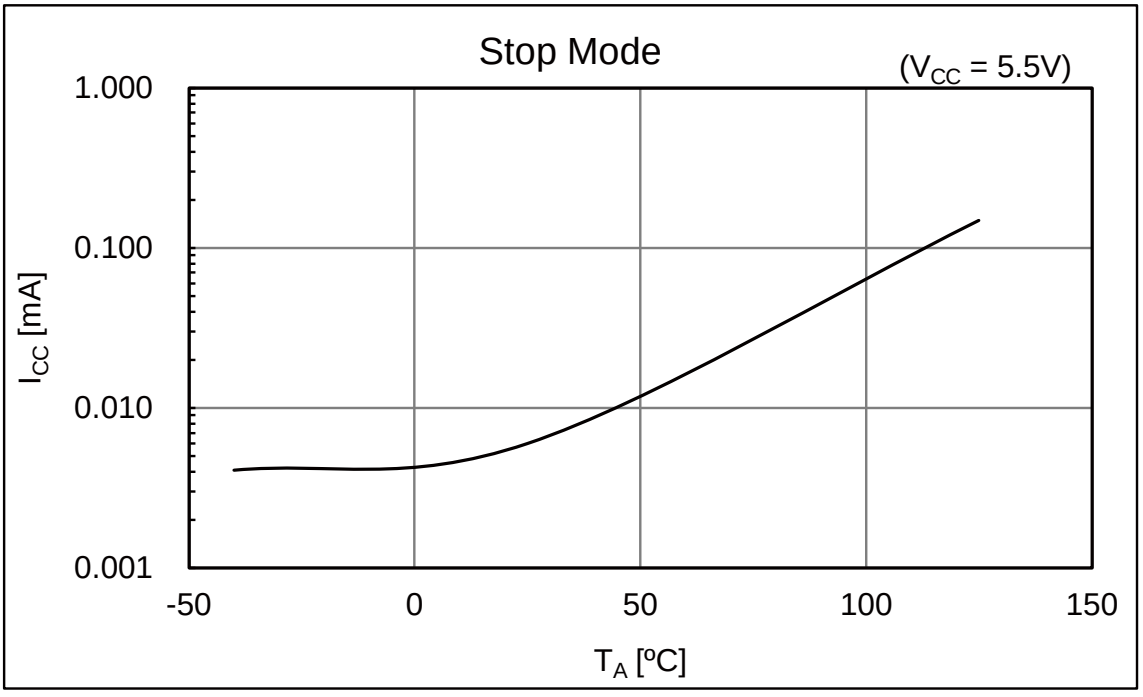

Timer Mode
(V_{CC} = 5.5V)
10.000
1.000
0.100
0.010
0.001
I_{CC} [mA]
PLL clock (32MHz)
Main osc. (4MHz)
RC clock (2MHz)
RC clock (100kHz)
Sub osc. (32kHz)
-50
0
50
100
150
T_A [ºC]


Stop Mode
(V_{CC} = 5.5V)
1.000
0.100
0.010
0.001
I_{CC} [mA]
-50
0
50
100
150
T_A [ºC]

16. Ordering Information

MCU with CAN controller

Part number	Flash memory	Package*
MB96F653RBPMC-GSE1	Flash A (96.5KB)	120-pin plastic LQFP (LQM120)
MB96F653RBPMC-GSE2		
MB96F655RBPMC-GSE1	Flash A (160.5KB)	120-pin plastic LQFP (LQM120)
MB96F655RBPMC-GSE2		
MB96F656RBPMC-GSE1	Flash A (288.5KB)	120-pin plastic LQFP (LQM120)
MB96F656RBPMC-GSE2		
MB96F657RBPMC-GSE1	Flash A (416.5KB)	120-pin plastic LQFP (LQM120)
MB96F657RBPMC-GSE2		

*: For details about package, see "Package Dimension".

MCU without CAN controller

Part number	Flash memory	Package*
MB96F653ABPMC-GSE1	Flash A (96.5KB)	120-pin plastic LQFP (LQM120)
MB96F653ABPMC-GSE2		
MB96F655ABPMC-GSE1	Flash A (160.5KB)	120-pin plastic LQFP (LQM120)
MB96F655ABPMC-GSE2		

*: For details about package, see "Package Dimension".